

STRIPPERS 400, KD, 14/HS, AND KS

GENERAL:

This range of strippers are designed to remove hard baked Kodak, Dynachem, Dow, and AZ photoresists without harm to the base laminate because of prolonged immersion.

Strippers 400 and KD will remove hard baked KPR I, II, III, IV and Dynachem.

Strippers 14/HS and KS will remove hard baked KMER, KTFR, AZ, and Dow.

APPLICATION:

1. Immerse part in stripper for approximately two minutes, or spray in a spray tank. Avoid carrying water into the tank. ALWAYS USE COLD.
2. Rinse with a forced water spray to remove resist and stripper. Use a brush with the spray rinse for printed circuits prior to plating or tinning. Do not dip into water before rinsing.

It may be necessary to use longer immersion times than indicated, depending on baking conditions. Under conditions of hard baking, brushing may be necessary.

HANDLING INSTRUCTIONS:

No neutralizer is necessary. Ventilation should be provided in the work area. Spray from machinery should be prevented from entering workshop atmosphere. Avoid contamination with water. DO NOT HEAT. Use in stainless steel, polyethylene or fiber-glass reinforced polyester tanks.